# PATENT ASSIGNMENT

Electronic Version v08 Stylesheet Version v02

SUBMISSION TYPE:

NEW ASSIGNMENT

APPLICATION NUMBER

10/907007

NATURE OF CONVEYANCE:

ASSIGNMENT OF ASSIGNOR'S INTEREST

#### **CONVEYING PARTY DATA**

Name	Execution Date
Tsung-Wei Shen	2005-03-14
Bo-Shao Soong	2005-03-14

#### RECEIVING PARTY DATA

Name	Street Address	Internal Address	City	State/Country	Postal Code
MICROELECTRONICS	No.3, Li-Hsin Road 2, Science-Based Industrial Park		Hsin-Chu City	TAIWAN	

### **CORRESPONDENCE DATA**

**FAX NUMBER:** 8064986673

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

When the customer number has been provided, the Office of Public Records will obtain the correspondence data from the official record on file at the USPTO.

CUSTOMER NUMBER: 027765

 NAME OF PERSON SIGNING:
 WINSTON HSU

 DATE SIGNED:
 2005-03-14

Total Attachments: 2

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PATENT REEL: 015782 FRAME: 0292

800017044

## **ASSIGNMENT OF INVENTION**

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration.

Name:	Tsung-Wei Shen	Nationality: R.O.C.				
Address:	: 14F, No. 157, Lane 89, Sec. 1, Guangfu Rd., Hsin-Chu City, Taiwan, R.O.C.					
Name:	Bo-Shao Soong	Nationality: R.O.C.				
Address:	S: No. 2, Lane 515, Wuchuan S. Rd., South District, Tai-Chung City, Taiwan, R.O.C.					
Hereby sells, as	ssigns and transfers to					
ASSIGNEE(S)						
Name:	UNITED MICROELECTRONICS CORP.					
Address:	No.3, Li-Hsin Road 2, Science-Based Industri	al Park, Hsin-Chu City, Taiwan, R.O.C.				
	sors and assignees of the ASSIGNEE the entire provements which are disclosed in the invention					
보다 불통하는 이 경우를 보는 것	KEY ON A WAFER"					
Which is foun	d in:					
(a) <u>+</u>	U.S. patent application executed on even date					
(b)	U.S. patent application executed on					
(c)	U.S. application serial no					
(d) r	patent no issued					

**ASSIGNOR(S)** (Inventors):

and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuation, division, renewal, or substitute thereof, and as to letters patent any reissue or re examination thereof

ASSIGNOR hereby covenants that no assignment sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment;

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the proposes thereof.

IN WITNESS WHEREOF, We har signing). (請發明人務必簽署上列日期。)	ve hereunto set hand and seal this	AR 7	4 2005	(Date of
(Type name of inventor)	Signature of INVENTOR			
Tsung-Wei Shen	Tsung-Wei Shen	· · · · · · · · · · · · · · · · · · ·		
Bo-Shao Soong	Bo-Shao Soong			

NPO#NAU-P0603-USA:0 CUST#UMCD-2004-0110

**RECORDED: 03/16/2005** 

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**PATENT** REEL: 015782 FRAME: 0294